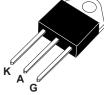


60 A, 1200 V standard SCR





TOP3 Isolated

Features

- Max. Repetitive Blocking Voltage = V_{DRM}, V_{RRM} = 1200 V
- I_{GT} maximum = 50 mA
- · High static and dynamic commutation:
 - dI/dt = 100 A/ μ s
 - dV/dt = 2000 V/ μ s
- ECOPACK®2 component (RoHS and HF compliance)
- Complies with UL 1557 standard (File ref : E81734)

Applications

- · Solar / Wind renewable energy inverters and rectifiers
- Solid state relay (SSR)
- Uninterruptible power supply (UPS)
- Industrial SMPS
- Bypass
- AC DC inrush current limiter (ICL)
- · Battery charger
- AC DC voltage controlled rectifier
- Industrial welding systems
- Off board automotive battery charger
- Soft starter
- Heating systems

Product status TN6050-12PI

Product summary				
Order code	TN6050-12PI			
Package	TOP3 isolated			
I _{T(RMS)}	60 A			
V _{DRM} /V _{RRM}	1200 V			
I _{GT}	50 mA			

Description

The TN6050-12PI SCR is suitable in industrial applications where high immunity is required with a lower gate current and ceramic isolated tab, UL1557 certified rated at 2.5 kV RMS and UL94-V0 resin compliance.

Available in through-hole high power package TOP3 isolated tab.



1 Characteristics

Table 1. Absolute maximum ratings (limiting values)

Symbol	Parameter				Unit
I _{T(RMS)}	On-state RMS current (180 ° conduction angle)			60	_
I _{T(AV)}	Average on-state current (180 ° conduction angle)		T _c = 82.2 °C	38	Α
1	Non repetitive surge peak on-state current (T _j initial = 25 °C)		t _p = 8.3 ms	763	_
I _{TSM}			t _p = 10 ms	700	Α
I ² t	I ² t value for fusing	t _p = 10 ms	2450	A ² s	
dl/dt	Critical rate of rise of on-state current $I_G = 100$ mA, $dI_g/dt = 1$ A/ μ s			100	A/µs
I _{GM}			T = 425 °C	8	Α
V_{GM}	Maximum peak positive gate voltage	t _p = 20 μs	T _j = 125 °C	5	V
P _{G(AV)}	Average gate power dissipation	T _j = 125 °C	1	W	
V_{RGM}	Maximum peak reverse gate voltage	3.5	V		
T _{stg}	Storage junction temperature range			-40 to +150	00
Tj	Operating junction temperature range	-40 to +125	°C		

Table 2. Electrical characteristics (T_j = 25 °C unless otherwise specified)

Symbol	Test conditions				Unit
I _{GT}			Min.	8	mA
'G1	$V_D = 12 \text{ V}, R_L = 33 \Omega$				IIIA
V _{GT}			Max.	1.3	V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$ $T_j = 125 ^{\circ}\text{C}$				V
I _H	I _T = 500 mA, gate open Max				mA
IL	$I_G = 1.2 \times I_{GT}$ Max.				mA
dV/dt	V_D = 67% V_{DRM} , gate open T_j = 125 °C M			2000	V/µs
t _{gt}	$I_T = 50 \text{ A}, V_D = V_{DRM}, I_G = 200 \text{ mA}, (dI_G/dt) \text{ max} = 0.2 \text{ A/}\mu\text{s}$ Typ.			2	μs
tq	I_{TM} = 50 A, V_D = 800 V, dI_{TM}/dt = 30 A/µs, V_R = 75 V, dV_D/dt = 20 V/µs T_j = 125 °C T_{yp}			100	μs

Table 3. Static characteristics

Symbol	Test conditions			Value	Unit
V _{TM}	I_{TM} = 120 A, t_p = 380 μ s	T _j = 25 °C	Max.	1.75 V	
V _{TO}	Threshold voltage	T _j = 125 °C	Max.	0.93	V
R _D	Dynamic resistance	T _j = 125 °C	Max.	7.1	mΩ
I _{DRM} , I _{RRM}	V _{DRM} = V _{RRM} = 1200 V	T _j = 25 °C	Max.	10	μA
		T _j = 125 °C	iviax.	6.5	mA

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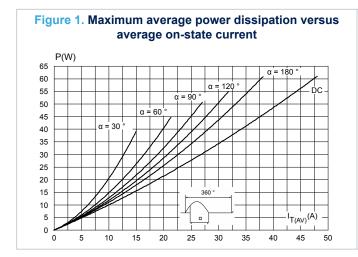


Table 4. Thermal parameters

Symbol	Parameter	Value	Unit	
R _{th(j-c)}	Junction to case (DC)	Тур.	0.70	°C/W
R _{th(j-a)}	Junction to ambient (DC)	тур.	50	C/VV



1.1 **Characteristics curves**



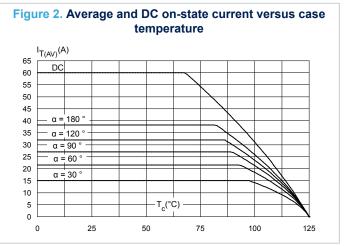
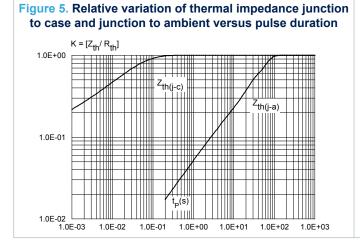
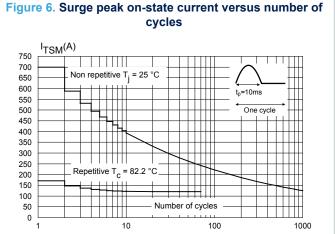


Figure 3. On-state characteristics (maximum values) $I_{TM}(A)$ 1000 100 $V_{t0} = 0.93 \text{ V}$ Rd = 7.1 m Ω 10 = 125 = 25 °C 1.5 2.0 2.5 4.0

Figure 4. Average and D.C. on-state current versus ambient temperature $I_{T(AV)}(A)$ 3.0 2.5 DC 2.0 $\alpha = 180$ 1.5 1.0 0.5 0.0 0 25 50 75 100 125





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Figure 7. Non repetitive surge peak on-state current for a sinusoidal pulse with width t_p < 10 ms

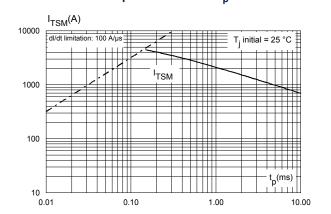


Figure 8. Relative variation of gate trigger current and gate trigger voltage versus junction temperature (typical value)

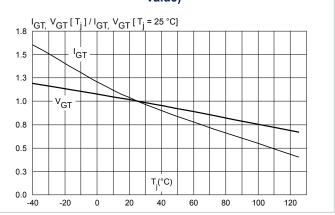


Figure 9. Relative variation of holding and latching current versus junction temperature (typical value)

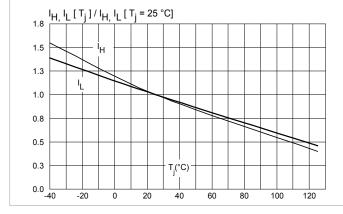


Figure 10. Relative variation of static dV/dt immunity versus junction temperature

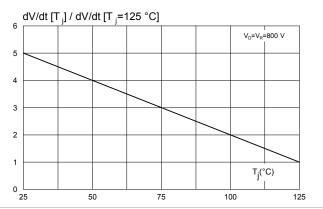
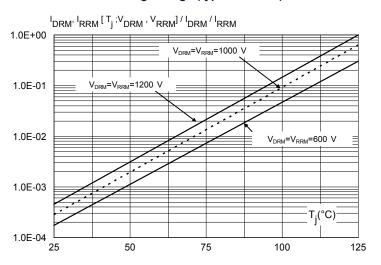


Figure 11. Relative variation of leakage current versus junction temperature for different values of blocking voltage (typical values)



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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 TOP3 Isolated package information

- ECOPACK® (Lead-free plating and Halogen free package compliance)
- · Lead-free package leads finishing
- Halogen-free molding compound resin meets UL94 standard level V0
- Recommended torque: 1.05 N·m (max. torque: 1.2 N·m)

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Usefull area for thermal contact 1 2 3

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Figure 12. TOP3 Isolated package outline

D



Table 5. TOP3 Isolated mechanical data

	Dimensions						
Ref.		mm			Inches ⁽¹⁾		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	4.40		4.60	0.1732		0.1811	
В	1.45		1.55	0.0571		0.0610	
С	14.35		15.60	0.5650		0.6142	
D	0.50		0.70	0.0197		0.0276	
Е	2.70		2.90	0.1063		0.1142	
F	15.80		16.50	0.6220		0.6496	
G	20.40		21.10	0.8031		0.8307	
Н	15.10		15.50	0.5945		0.6102	
J	5.40		5.65	0.2126		0.2224	
K	3.40		3.65	0.1339		0.1437	
L	4.08		4.17	0.1606		0.1642	
М	1.20		1.40	0.0472		0.0551	
R		4.60			0.1811		

^{1.} Inches given for reference only

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3 Ordering information

Figure 13. Ordering information scheme

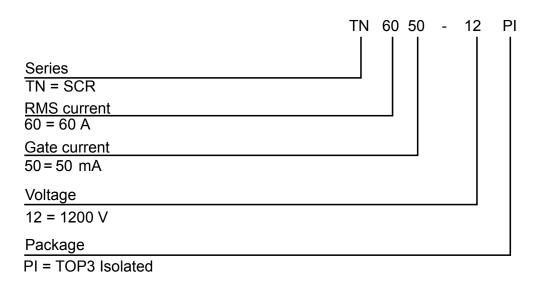


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
TN6050-12PI	TN605012PI	TOP3 Isolated	4.48 g	30	Tube

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Revision history

Table 7. Document revision history

Date	Revision	Changes
14-Dec-2018	1	Initial release.



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